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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	6100
Total RAM Bits	94208
Number of I/O	97
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec6e-3t144i

Introduction

The LatticeECP/EC family of FPGA devices is optimized to deliver mainstream FPGA features at low cost. For maximum performance and value, the LatticeECP™ (Economy Plus) FPGA concept combines an efficient FPGA fabric with high-speed dedicated functions. Lattice's first family to implement this approach is the LatticeECP-DSP™ (Economy Plus DSP) family, providing dedicated high-performance DSP blocks on-chip. The LatticeEC™ (Economy) family supports all the general purpose features of LatticeECP devices without dedicated function blocks to achieve lower cost solutions.

The LatticeECP/EC FPGA fabric, which was designed from the outset with low cost in mind, contains all the critical FPGA elements: LUT-based logic, distributed and embedded memory, PLLs and support for mainstream I/Os. Dedicated DDR memory interface logic is also included to support this memory that is becoming increasingly prevalent in cost-sensitive applications.

The ispLEVER® design tool suite from Lattice allows large complex designs to be efficiently implemented using the LatticeECP/EC FPGA family. Synthesis library support for LatticeECP/EC is available for popular logic synthesis tools. The ispLEVER tool uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP/EC device. The ispLEVER tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-designed IP (Intellectual Property) ispLeverCORE™ modules for the LatticeECP/EC family. By using these IPs as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Table 2-7. Maximum Number of Elements in a Block

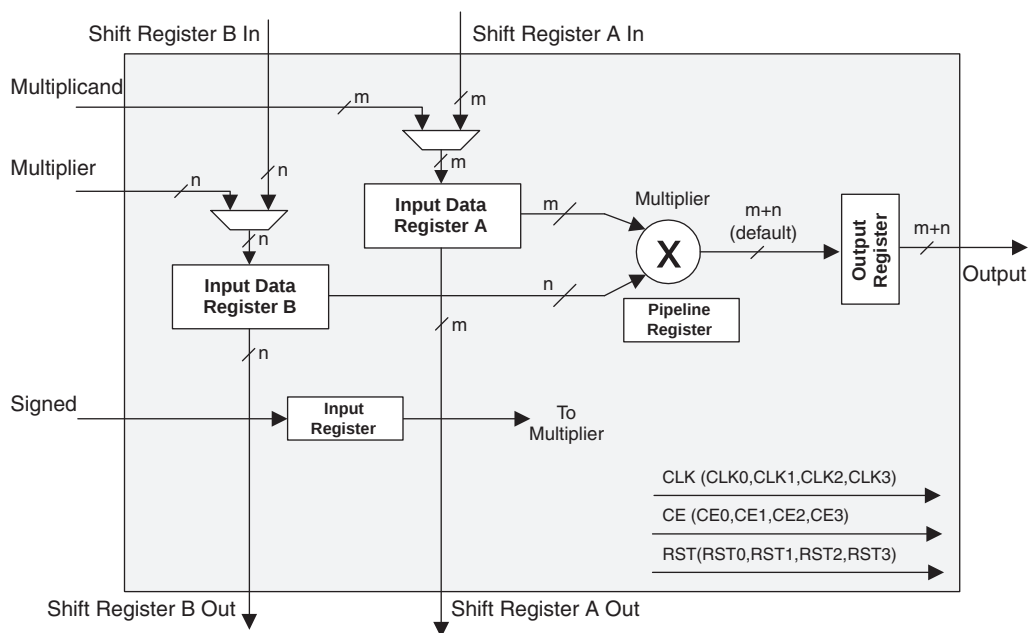
Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADD	4	2	—
MULTADDSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as shift registers from previous operand registers. In addition by selecting “dynamic operation” in the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle. Similarly by selecting ‘Dynamic operation’ in the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-19 shows the MULT sysDSP element.

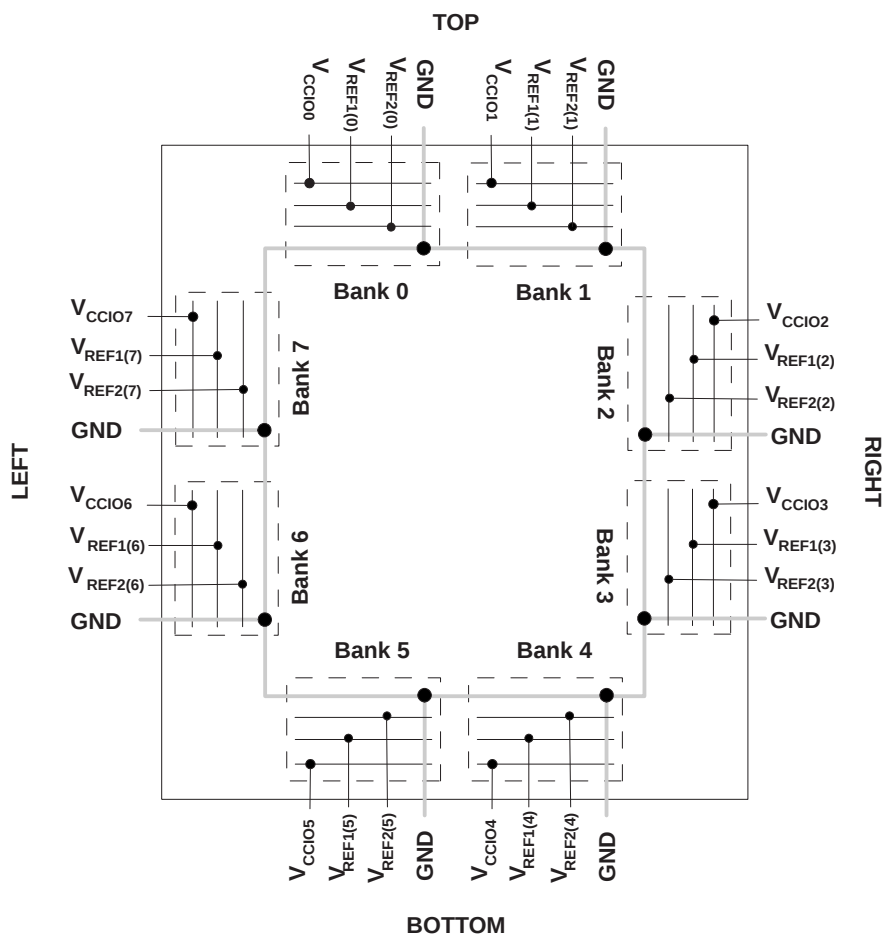
Figure 2-19. MULT sysDSP Element



MAC sysDSP Element

In this case the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers but the output register is always enabled. The output register is used to store the accumulated value. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-20 shows the MAC sysDSP element.

Figure 2-34. LatticeECP/EC Banks



LatticeECP/EC devices contain two types of sysI/O buffer pairs.

1. **Top and Bottom sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the top and bottom banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

Only the I/Os on the top and bottom banks have programmable PCI clamps. These I/O banks also support hot socketing with I_{DK} less than 1mA. Note that the PCI clamp is enabled after V_{CC} , V_{CCAUX} and V_{CCIO} are at valid operating levels and the device has been configured.

2. **Left and Right sysI/O Buffer Pairs (Differential and Single-Ended Outputs)**

The sysI/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. The referenced input buffer can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

Only the left and right banks have LVDS differential output drivers. See the I_{DK} specification for I/O leakage current during power-up.

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC}	-0.5 to 1.32V
Supply Voltage V_{CCAUX}	-0.5 to 3.75V
Supply Voltage V_{CCJ}	-0.5 to 3.75V
Output Supply Voltage V_{CCIO}	-0.5 to 3.75V
Dedicated Input Voltage Applied ⁴	-0.5 to 4.25V
I/O Tristate Voltage Applied ⁴	-0.5 to 3.75V
Storage Temperature (Ambient)	-65 to 150°C
Junction Temp. (Tj)	+125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice *Thermal Management* document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V_{CC}	Core Supply Voltage	1.14	1.26	V
V_{CCAUX}^3	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage for ECP/EC33	1.14	1.26	V
$V_{CCIO}^{1, 2}$	I/O Driver Supply Voltage	1.140	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.140	3.465	V
t_{JCOM}	Junction Commercial Operation	0	85	°C
t_{JIND}	Junction Industrial Operation	-40	100	°C

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} .
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 3mV/ μ s for commercial and 0.6 mV/ μ s for industrial device operations during power up when transitioning between 0.8V and 1.8V.

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Top and Bottom General Purpose sysI/Os (Banks 0, 1, 4 and 5), JTAG and Dedicated sysCONFIG Pins						
I_{DK_TB}	Input or I/O Leakage Current	0 δ V_{IN} δ V_{IH} (MAX.)	—	—	+/-1000	μ A
Left and Right General Purpose sysI/Os (Banks 2, 3, 6 and 7)						
I_{DK_LR}	Input or I/O Leakage Current	$V_{IN} \delta V_{CCIO}$	—	—	+/-1000	μ A
		$V_{IN} > V_{CCIO}$	—	35	—	mA

1. Insensitive to sequence of V_{CC} , V_{CCAUX} and V_{CCIO} . However, assumes monotonic rise/fall rates for V_{CC} , V_{CCAUX} and V_{CCIO} .
2. 0 δ $V_{CC} \delta V_{CC}$ (MAX), 0 δ $V_{CCIO} \delta V_{CCIO}$ (MAX) or 0 δ $V_{CCAUX} \delta V_{CCAUX}$ (MAX).
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.

sysI/O Recommended Operating Conditions

Standard	V _{CCIO}			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 3.3	3.135	3.3	3.465	—	—	—
LVC MOS 2.5	2.375	2.5	2.625	—	—	—
LVC MOS 1.8	1.71	1.8	1.89	—	—	—
LVC MOS 1.5	1.425	1.5	1.575	—	—	—
LVC MOS 1.2	1.14	1.2	1.26	—	—	—
LVTTL	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18 Class I	1.71	1.8	1.89	0.833	0.90	0.969
SSTL2 Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3 Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15 Class III	1.425	1.5	1.575	—	0.9	—
HSTL 18 Class I, II	1.71	1.8	1.89	—	0.9	—
HSTL 18 Class III	1.71	1.8	1.89	—	1.08	—
LVDS	2.375	2.5	2.625	—	—	—
LVPECL ¹	3.135	3.3	3.465	—	—	—
BLVDS ¹	2.375	2.5	2.625	—	—	—
RSDS ¹	2.375	2.5	2.625	—	—	—

1. Outputs are implemented with the addition of external resistors. V_{CCIO} applies to outputs only.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35V_{CC}$	$0.65V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3V_{CCIO}$	$0.5V_{CCIO}$	3.6	$0.1V_{CCIO}$	$0.9V_{CCIO}$	1.5	-0.5
SSTL3 class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
SSTL2 class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
SSTL18 class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
HSTL15 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
HSTL15 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8
HSTL18 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	9.6	-9.6
HSTL18 class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16
HSTL18 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

Timing Diagrams

PFU Timing Diagrams

Figure 3-6. Slice Single/Dual Port Write Cycle Timing

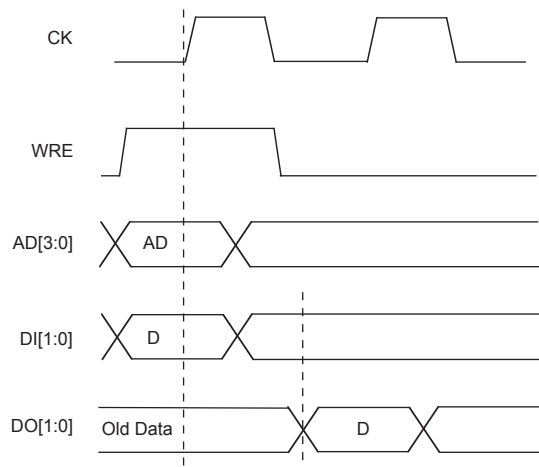
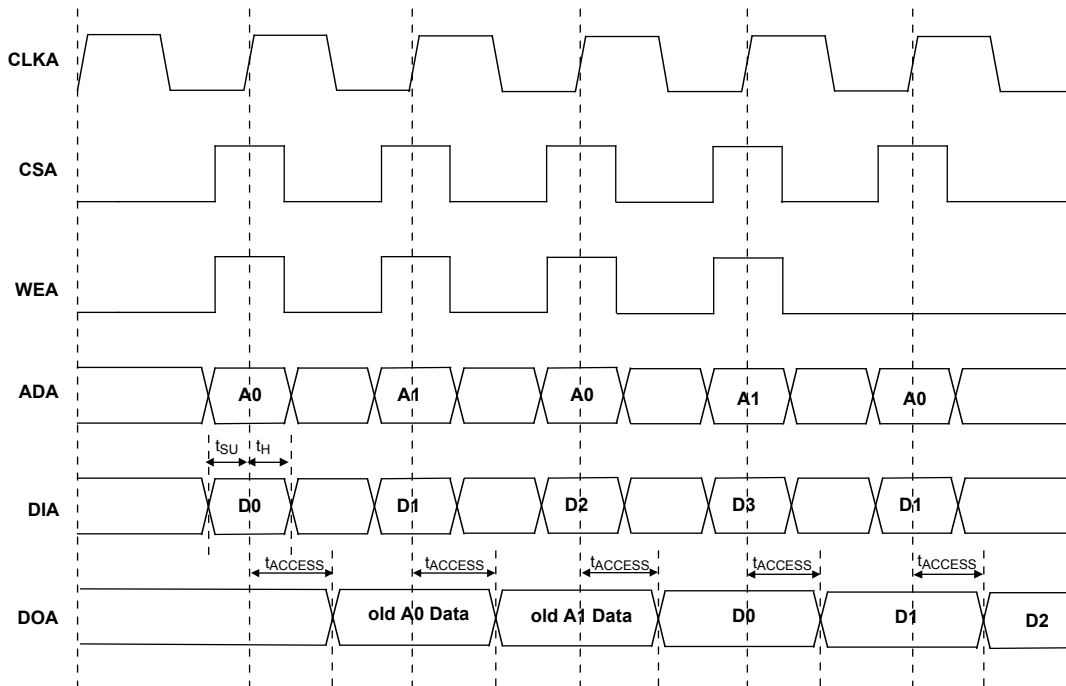


Figure 3-7. Slice Single /Dual Port Read Cycle Timing

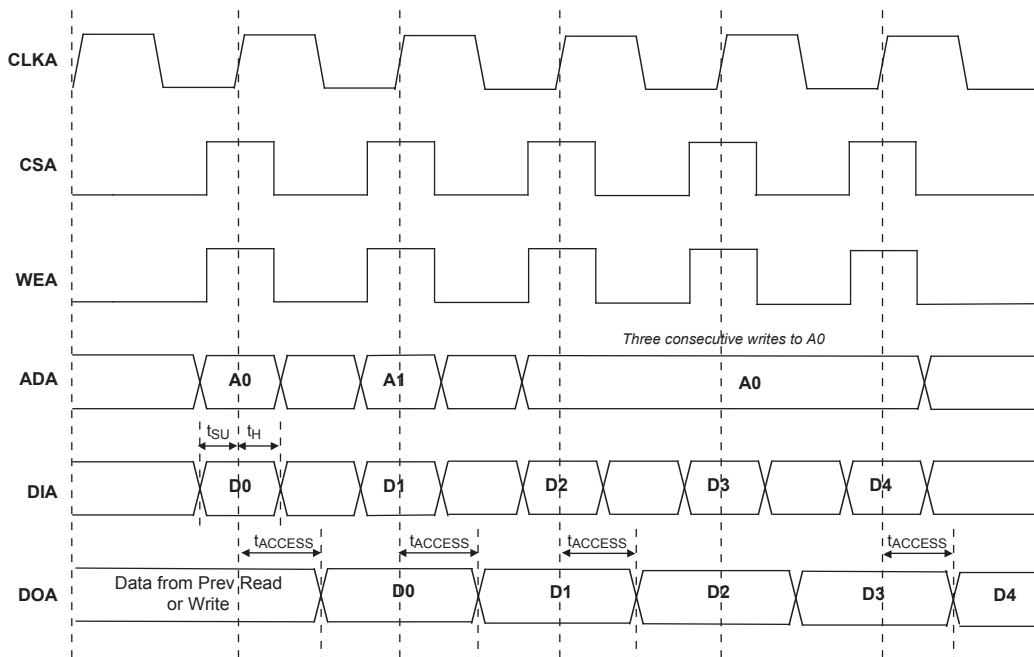


Figure 3-10. Read Before Write (SP Read/Write on Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

Figure 3-11. Write Through (SP Read/Write On Port A, Input Registers Only)



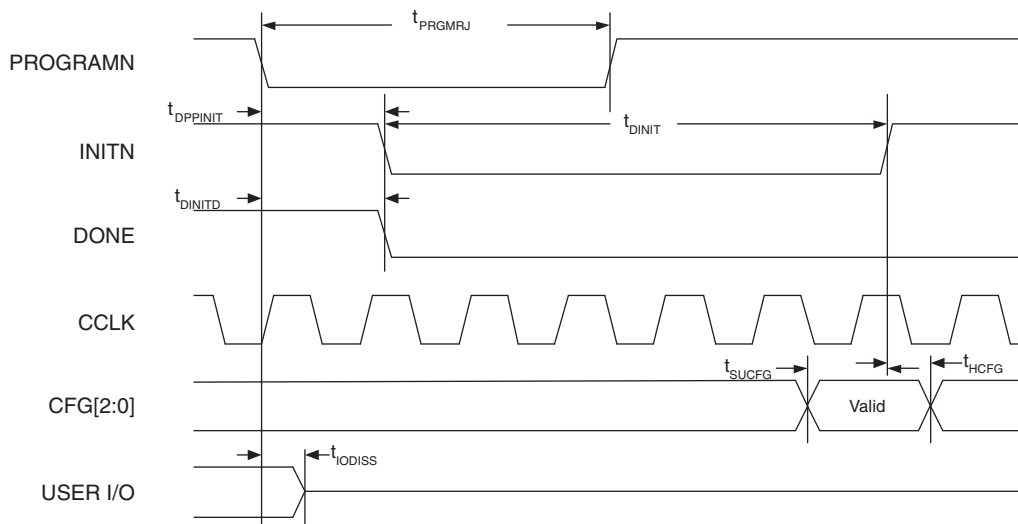
Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

LatticeECP/EC Family Timing Adders^{1, 2, 3}

Over Recommended Operating Conditions

Buffer Type	Description	-5	-4	-3	Units
Input Adjusters					
LVDS25	LVDS	0.41	0.50	0.58	ns
BLVDS25	BLVDS	0.41	0.50	0.58	ns
LVPECL33	LVPECL	0.50	0.60	0.70	ns
HSTL18_I	HSTL_18 class I	0.41	0.49	0.57	ns
HSTL18_II	HSTL_18 class II	0.41	0.49	0.57	ns
HSTL18_III	HSTL_18 class III	0.41	0.49	0.57	ns
HSTL18D_I	Differential HSTL 18 class I	0.37	0.44	0.52	ns
HSTL18D_II	Differential HSTL 18 class II	0.37	0.44	0.52	ns
HSTL18D_III	Differential HSTL 18 class III	0.37	0.44	0.52	ns
HSTL15_I	HSTL_15 class I	0.40	0.48	0.56	ns
HSTL15_III	HSTL_15 class III	0.40	0.48	0.56	ns
HSTL15D_I	Differential HSTL 15 class I	0.37	0.44	0.51	ns
HSTL15D_III	Differential HSTL 15 class III	0.37	0.44	0.51	ns
SSTL33_I	SSTL_3 class I	0.46	0.55	0.64	ns
SSTL33_II	SSTL_3 class II	0.46	0.55	0.64	ns
SSTL33D_I	Differential SSTL_3 class I	0.39	0.47	0.55	ns
SSTL33D_II	Differential SSTL_3 class II	0.39	0.47	0.55	ns
SSTL25_I	SSTL_2 class I	0.43	0.51	0.60	ns
SSTL25_II	SSTL_2 class II	0.43	0.51	0.60	ns
SSTL25D_I	Differential SSTL_2 class I	0.38	0.45	0.53	ns
SSTL25D_II	Differential SSTL_2 class II	0.38	0.45	0.53	ns
SSTL18_I	SSTL_18 class I	0.40	0.48	0.56	ns
SSTL18D_I	Differential SSTL_18 class I	0.37	0.44	0.51	ns
LVTTL33	LVTTL	0.07	0.09	0.10	ns
LVC MOS33	LVC MOS 3.3	0.07	0.09	0.10	ns
LVC MOS25	LVC MOS 2.5	0.00	0.00	0.00	ns
LVC MOS18	LVC MOS 1.8	0.07	0.09	0.10	ns
LVC MOS15	LVC MOS 1.5	0.24	0.29	0.33	ns
LVC MOS12	LVC MOS 1.2	1.27	1.52	1.77	ns
PCI33	PCI	0.07	0.09	0.10	ns
Output Adjusters					
LVDS25E	LVDS 2.5 E	0.12	0.14	0.17	ns
LVDS25	LVDS 2.5	-0.44	-0.53	-0.62	ns
BLVDS25	BLVDS 2.5	0.33	0.40	0.46	ns
LVPECL33	LVPECL 3.3	0.20	0.24	0.28	ns
HSTL18_I	HSTL_18 class I	-0.10	-0.12	-0.14	ns
HSTL18_II	HSTL_18 class II	0.06	0.07	0.08	ns
HSTL18_III	HSTL_18 class III	0.15	0.19	0.22	ns
HSTL18D_I	Differential HSTL 18 class I	-0.10	-0.12	-0.14	ns
HSTL18D_II	Differential HSTL 18 class II	0.06	0.07	0.08	ns
HSTL18D_III	Differential HSTL 18 class III	0.15	0.19	0.22	ns
HSTL15_I	HSTL_15 class I	0.08	0.10	0.11	ns

Figure 3-17. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-18. Wake-Up Timing

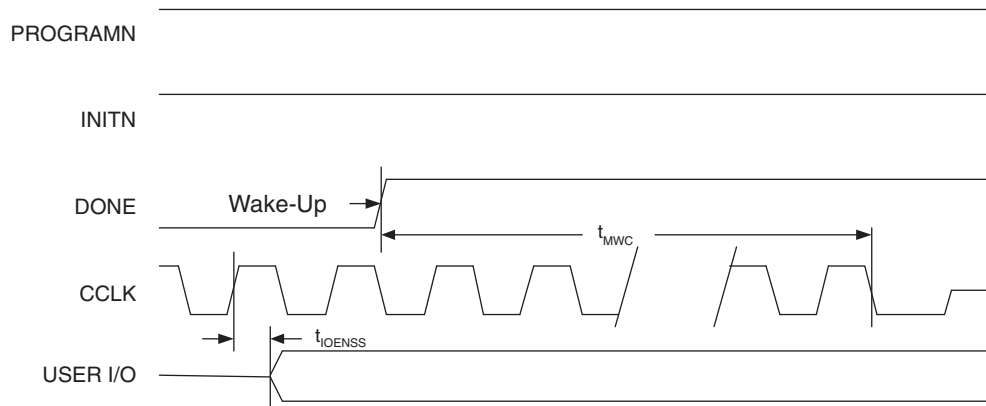
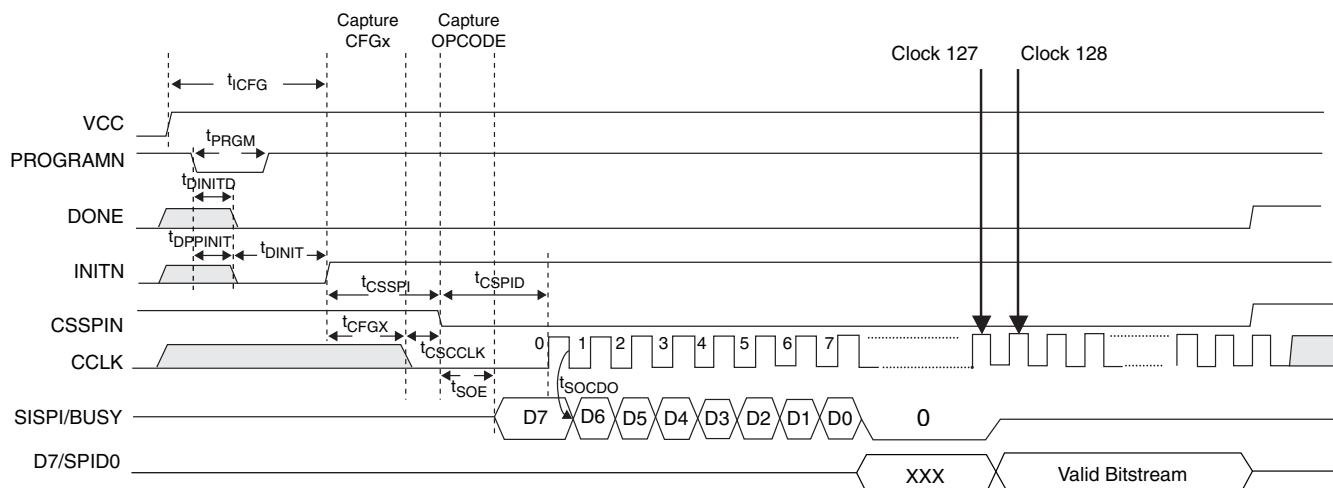


Figure 3-19. sysCONFIG SPI Port Sequence



Power Supply and NC Connections (Cont.)

Signals	484 fpBGA	672 fpBGA
VCC	J16, J7, K16, K17, K6, K7, L17, L6, M17, M6, N16, N17, N6, N7, P16, P7, J6, J17, P6, P17	H10, H11, H16, H17, H18, H19, H8, H9, J18, J9, K8, L19, M19, N7, R20, R7, T19, V18, V8, V9, W10, W11, W16, W17, W18, W19, W8, W9, K19, L8, U19, U8
VCCIO0	G11, H10, H11, H9	H12, H13, J10, J11, J12, J13
VCCIO1	G12, H12, H13, H14	H14, H15, J14, J15, J16, J17
VCCIO2	J15, K15, L15, L16	K17, K18, L18, M18, N18, N19
VCCIO3	M15, M16, N15, P15	P18, P19, R18, R19, T18, U18
VCCIO4	R12, R13, R14, T12	V14, V15, V16, V17, W14, W15
VCCIO5	R10, R11, R9, T11	V10, V11, V12, V13, W12, W13
VCCIO6	M7, M8, N8, P8	P8, P9, R8, R9, T9, U9
VCCIO7	J8, K8, L7, L8	K9, L9, M8, M9, N8, N9
VCCJ	U2	U6
VCCAUX	G15, G16, G7, G8, H16, H7, R16, R7, T15, T16, T7, T8	G13, H20, H7, J19, J8, K7, L20, M20, M7, N20, P20, P7, T20, T7, T8, V19, V7, W20, Y13, Y7
VCCPLL	ECP/EC20: None ECP/EC33: J6, J17, P6, P17	ECP/EC20: None ECP/EC33: K19, L8, U19, U8
GND, GND0-GND7	A1, A22, AB1, AB22, H15, H8, J10, J11, J12, J13, J14, J9, K10, K11, K12, K13, K14, K9, L10, L11, L12, L13, L14, L9, M10, M11, M12, M13, M14, M9, N10, N11, N12, N13, N14, N9, P10, P11, P12, P13, P14, P9, R15, R8	K10, K11, K12, K13, K14, K15, K16, L10, L11, L12, L13, L14, L15, L16, L17, M10, M11, M12, M13, M14, M15, M16, M17, N10, N11, N12, N13, N14, N15, N16, N17, P10, P11, P12, P13, P14, P15, P16, P17, R10, R11, R12, R13, R14, R15, R16, R17, T10, T11, T12, T13, T14, T15, T16, T17, U10, U11, U12, U13, U14, U15, U16, U17
NC	ECP/EC6: C3, B2, E5, F5, D3, C2, F4, G4, E3, D2, B1, C1, F3, E2, G5, H6, G3, H4, J5, H5, F2, F1, E1, D1, R6, P5, P3, P4, R1, R2, R5, R4, T1, T2, R3, T3, V7, T6, V8, U7, W5, U6, AA3, AB3, Y6, V6, AA5, W6, Y5, Y4, AA4, AB4, W16, U15, V16, U16, Y17, V17, AB20, AA19, Y16, W17, AA20, Y19, Y18, W18, T17, U17, T18, R17, R19, R18, U22, T22, R21, R22, P20, N20, P19, P18, E21, D22, G21, G20, J18, H19, J19, H20, H17, H18, D21, C22, G19, G18, F20, F19, E20, D20, C21, C20, F18, E18, B22, B21, G17, F17, D18, C18, C19, B20, D17, C16, B19, A20, E17, C17, F16, E16, F15, D16, A4, B4, C4, C5, D6, B5, E6, C6, A3, B3, F6, D5, F7, E8, G6, E7, A2, AB2, A21 ECP/EC10: G5, H6, G3, H4, J5, H5, F2, F1, R6, P5, P3, P4, R2, R1, R5, R4, T1, T2, R3, T3, W16, U15, V16, U16, Y17, V17, AB20, AA19, Y16, W17, AA20, Y19, Y18, W18, T17, U17, T18, R17, R19, R18, U22, T22, R21, R22, P20, N20, P19, P18, G21, G20, J18, H19, J19, H20, H17, H18, G17, F17, D18, C18, C19, B20, D17, C16, B19, A20, E17, C17, F16, E16, F15, D16, A2, AB2, A21 ECP/EC15: T1, T2, R3, T3, T18, R17, R19, R18, A2, AB2, A21 ECP/EC20: A2, AB2, A21 ECP/EC33: A2, AB2, A21	ECP/EC20: E5, D5, F4, F5, C3, D3, C2, B2, H6, J7, G5, H5, H3, J3, H2, J2, AA2, AA3, W5, Y5, Y6, W7, AA4, AB3, AC2, AC3, AA5, AB5, AD3, AD2, AE1, AD1, AD19, AD20, AC19, AB19, AD21, AC20, AF25, AE25, AB21, AB20, AE24, AD23, AD22, AC21, AC22, AB22, AD24, AD25, AE26, AD26, Y20, Y19, AA23, AA22, AB23, AB24, Y21, AA21, Y23, Y22, AA24, Y24, J21, J22, J23, H22, G26, F26, E26, E25, F24, F23, E24, D24, E22, F22, E21, D22, G20, F20, D21, C21, C23, C22, B23, C24, D20, E19, B25, B24, B26, A25, C20, C19 ECP/EC33: None

LFEC1, LFEC3 Logic Signal Connections: 100 TQFP

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	PL3A	7	T		PL7A	7	T	
6	PL3B	7	C		PL7B	7	C	
7	PL4A	7	T		PL8A	7	T	
8	PL4B	7	C		PL8B	7	C	
9	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
10	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
11	XRES	6			XRES	6		
12	VCC	-			VCC	-		
13	TCK	6			TCK	6		
14	GND	-			GND	-		
15	TDI	6			TDI	6		
16	TMS	6			TMS	6		
17	TDO	6			TDO	6		
18	VCCJ	6			VCCJ	6		
19	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LUM0_PLLT_IN_A
20	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LUM0_PLLC_IN_A
21	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LUM0_PLLT_FB_A
22	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LUM0_PLLC_FB_A
23	PL14A	6		VREF1_6	PL18A	6		VREF1_6
24	VCCIO6	6			VCCIO6	6		
25*	GND5 GND6	-			GND5 GND6	-		
26	VCCIO5	5			VCCIO5	5		
27	PB2A	5	T		PB10A	5	T	
28	PB2B	5	C		PB10B	5	C	
29	PB3A	5	T		PB11A	5	T	
30	PB3B	5	C		PB11B	5	C	
31	PB6A	5		BDQS6	PB14A	5		BDQS14
32	PB8A	5	T	VREF2_5	PB16A	5	T	VREF2_5
33	PB8B	5	C	VREF1_5	PB16B	5	C	VREF1_5
34	PB9A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
35	GND5	5			GND5	5		
36	PB9B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
37	VCCAUX	-			VCCAUX	-		
38	VCCIO4	4			VCCIO4	4		
39	PB10A	4	T	WRITEN	PB18A	4	T	WRITEN
40	PB10B	4	C	CS1N	PB18B	4	C	CS1N

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	NC	-			NC	-		
6	NC	-			NC	-		
7	NC	-			PL3B	7		
8	NC	-			PL4A	7	T	
9	NC	-			PL4B	7	C	
10	NC	-			PL5A	7	T	
11	NC	-			PL5B	7	C	
12	NC	-			PL6A	7	T	LDQS6
13	NC	-			VCCIO7	7		
14	NC	-			PL6B	7	C	
15	PL3A	7	T		PL7A	7	T	
16	PL3B	7	C		PL7B	7	C	
17	PL4A	7	T		PL8A	7	T	
18	NC	-			NC	-		
19	PL4B	7	C		PL8B	7	C	
20	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
21	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
22	NC	-			VCCAUX	-		
23	XRES	6			XRES	6		
24	NC	-			NC	-		
25	NC	-			NC	-		
26	VCC	-			VCC	-		
27	TCK	6			TCK	6		
28	GND	-			GND	-		
29	TDI	6			TDI	6		
30	TMS	6			TMS	6		
31	TDO	6			TDO	6		
32	VCCJ	6			VCCJ	6		
33	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LLM0_PLLT_IN_A
34	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LLM0_PLLC_IN_A
35	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LLM0_PLLT_FB_A
36	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LLM0_PLLC_FB_A
37	VCCIO6	6			VCCIO6	6		
38	PL9A	6	T		PL13A	6	T	
39	PL9B	6	C		PL13B	6	C	
40	PL10A	6	T		PL14A	6	T	
41	GND6	6			GND6	6		
42	PL10B	6	C		PL14B	6	C	

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
K3	PL21A	7	T		K3	PL33A	7	T	
K2	PL21B	7	C		K2	PL33B	7	C	
J1	PL22A	7	T	PCLKT7_0	J1	PL34A	7	T	PCLKT7_0
GND	GND7	7			GND	GND7	7		
K1	PL22B	7	C	PCLKC7_0	K1	PL34B	7	C	PCLKC7_0
L3	XRES	6			L3	XRES	6		
L4	PL24A	6	T		L4	PL36A	6	T	
L5	PL24B	6	C		L5	PL36B	6	C	
L2	PL25A	6	T		L2	PL37A	6	T	
L1	PL25B	6	C		L1	PL37B	6	C	
M4	PL26A	6	T		M4	PL38A	6	T	
M5	PL26B	6	C		M5	PL38B	6	C	
M1	PL27A	6	T		M1	PL39A	6	T	
GND	GND6	6			GND	GND6	6		
M2	PL27B	6	C		M2	PL39B	6	C	
N3	PL28A	6	T	LDQS28	N3	PL40A	6	T	LDQS40
M3	PL28B	6	C		M3	PL40B	6	C	
N5	PL29A	6	T		N5	PL41A	6	T	
N4	PL29B	6	C		N4	PL41B	6	C	
N1	PL30A	6	T		N1	PL42A	6	T	
N2	PL30B	6	C		N2	PL42B	6	C	
P1	PL31A	6	T		P1	PL43A	6	T	
GND	GND6	6			GND	GND6	6		
P2	PL31B	6	C		P2	PL43B	6	C	
R6	PL32A	6	T		R6	PL44A	6	T	
P5	PL32B	6	C		P5	PL44B	6	C	
P3	PL33A	6	T		P3	PL45A	6	T	
P4	PL33B	6	C		P4	PL45B	6	C	
R1	PL34A	6	T		R1	PL46A	6	T	
R2	PL34B	6	C		R2	PL46B	6	C	
R5	PL35A	6	T		R5	PL47A	6	T	
GND	GND6	6			GND	GND6	6		
R4	PL35B	6	C		R4	PL47B	6	C	
T1	PL36A	6	T	LDQS36	T1	PL48A	6	T	LDQS48
T2	PL36B	6	C		T2	PL48B	6	C	
R3	PL37A	6	T		R3	PL49A	6	T	
T3	PL37B	6	C		T3	PL49B	6	C	
GND	GND6	6			GND	GND6	6		
T5	TCK	6			T5	TCK	6		
U5	TDI	6			U5	TDI	6		
T4	TMS	6			T4	TMS	6		
U1	TDO	6			U1	TDO	6		
U2	VCCJ	6			U2	VCCJ	6		
V1	PL41A	6	T	LLM0_PLLT_IN_A	V1	PL53A	6	T	LLM0_PLLT_IN_A

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND	GND7	7		
E3	PL2A	7	T	VREF2_7	E3	PL2A	7	T	VREF2_7
E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7
E5	NC	-			E5	PL6A	7	T	LDQS6
D5	NC	-			D5	PL6B	7	C	
F4	NC	-			F4	PL7A	7	T	
F5	NC	-			F5	PL7B	7	C	
C3	NC	-			C3	PL8A	7	T	
D3	NC	-			D3	PL8B	7	C	
C2	NC	-			C2	PL9A	7	T	
-	-	-			GND	GND7	7		
B2	NC	-			B2	PL9B	7	C	
B1	PL3A	7	T		B1	PL10A	7	T	
C1	PL3B	7	C		C1	PL10B	7	C	
F3	PL4A	7	T		F3	PL11A	7	T	
G3	PL4B	7	C		G3	PL11B	7	C	
D2	PL5A	7	T		D2	PL12A	7	T	
E2	PL5B	7	C		E2	PL12B	7	C	
-	-	-			GND	GND7	7		
D1	PL6A	7	T	LDQS6	D1	PL14A	7	T	LDQS14
E1	PL6B	7	C		E1	PL14B	7	C	
F2	PL7A	7	T		F2	PL15A	7	T	
G2	PL7B	7	C		G2	PL15B	7	C	
F6	PL8A	7	T	LUM0_PLLT_IN_A	F6	PL16A	7	T	LUM0_PLLT_IN_A
G6	PL8B	7	C	LUM0_PLLC_IN_A	G6	PL16B	7	C	LUM0_PLLC_IN_A
H4	PL9A	7	T	LUM0_PLLT_FB_A	H4	PL17A	7	T	LUM0_PLLT_FB_A
GND	GND7	7			GND	GND7	7		
G4	PL9B	7	C	LUM0_PLLC_FB_A	G4	PL17B	7	C	LUM0_PLLC_FB_A
H6	NC	-			H6	PL19A	7	T	
J7	NC	-			J7	PL19B	7	C	
G5	NC	-			G5	PL20A	7	T	
H5	NC	-			H5	PL20B	7	C	
H3	NC	-			H3	PL21A	7	T	
J3	NC	-			J3	PL21B	7	C	
H2	NC	-			H2	PL22A	7	T	
-	-	-			GND	GND7	7		
J2	NC	-			J2	PL22B	7	C	
J4	PL11A	7	T		J4	PL23A	7	T	LDQS23
J5	PL11B	7	C		J5	PL23B	7	C	
K4	PL12A	7	T		K4	PL24A	7	T	
K5	PL12B	7	C		K5	PL24B	7	C	
J6	PL13A	7	T		J6	PL25A	7	T	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
P5	PL32B	6	C		P5	PL44B	6	C	
P6	PL33A	6	T		P6	PL45A	6	T	
R5	PL33B	6	C		R5	PL45B	6	C	
U1	PL34A	6	T		U1	PL46A	6	T	
U2	PL34B	6	C		U2	PL46B	6	C	
T3	PL35A	6	T		T3	PL47A	6	T	
GND	GND6	6			GND	GND6	6		
T4	PL35B	6	C		T4	PL47B	6	C	
R6	PL36A	6	T	LDQS36	R6	PL48A	6	T	LDQS48
T5	PL36B	6	C		T5	PL48B	6	C	
T6	PL37A	6	T		T6	PL49A	6	T	
U5	PL37B	6	C		U5	PL49B	6	C	
U3	PL38A	6	T		U3	PL50A	6	T	
U4	PL38B	6	C		U4	PL50B	6	C	
V1	PL39A	6	T		V1	PL51A	6	T	
GND	GND6	6			GND	GND6	6		
V2	PL39B	6	C		V2	PL51B	6	C	
U7	TCK	6			U7	TCK	6		
V4	TDI	6			V4	TDI	6		
V5	TMS	6			V5	TMS	6		
V3	TDO	6			V3	TDO	6		
U6	VCCJ	6			U6	VCCJ	6		
W1	PL41A	6	T	LLM0_PLLT_IN_A	W1	PL53A	6	T	LLM0_PLLT_IN_A
W2	PL41B	6	C	LLM0_PLLC_IN_A	W2	PL53B	6	C	LLM0_PLLC_IN_A
V6	PL42A	6	T	LLM0_PLLT_FB_A	V6	PL54A	6	T	LLM0_PLLT_FB_A
W6	PL42B	6	C	LLM0_PLLC_FB_A	W6	PL54B	6	C	LLM0_PLLC_FB_A
Y1	PL43A	6	T		Y1	PL55A	6	T	
Y2	PL43B	6	C		Y2	PL55B	6	C	
W3	PL44A	6	T		W3	PL56A	6	T	
GND	GND6	6			GND	GND6	6		
W4	PL44B	6	C		W4	PL56B	6	C	
AA1	PL45A	6	T	LDQS45	AA1	PL57A	6	T	LDQS57
AB1	PL45B	6	C		AB1	PL57B	6	C	
Y4	PL46A	6	T		Y4	PL58A	6	T	
Y3	PL46B	6	C		Y3	PL58B	6	C	
AC1	PL47A	6	T		AC1	PL59A	6	T	
AB2	PL47B	6	C		AB2	PL59B	6	C	
AA2	NC	-			AA2	PL60A	6	T	
-	-	-			GND	GND6	6		
AA3	NC	-			AA3	PL60B	6	C	
W5	NC	-			W5	PL61A	6	T	
Y5	NC	-			Y5	PL61B	6	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
L24	PR17A	2	T		L24	PR29A	2	T	
K25	PR16B	2	C		K25	PR28B	2	C	
J25	PR16A	2	T		J25	PR28A	2	T	
J26	PR15B	2	C		J26	PR27B	2	C	
H26	PR15A	2	T		H26	PR27A	2	T	
H25	PR14B	2	C		H25	PR26B	2	C	
GND	GND2	2			GND	GND2	2		
J24	PR14A	2	T		J24	PR26A	2	T	
K21	PR13B	2	C		K21	PR25B	2	C	
K22	PR13A	2	T		K22	PR25A	2	T	
K20	PR12B	2	C		K20	PR24B	2	C	
J20	PR12A	2	T		J20	PR24A	2	T	
K23	PR11B	2	C		K23	PR23B	2	C	
K24	PR11A	2	T		K24	PR23A	2	T	RDQS23
J21	NC	-			J21	PR22B	2	C	
-	-	-			GND	GND2	2		
J22	NC	-			J22	PR22A	2	T	
J23	NC	-			J23	PR21B	2	C	
H22	NC	-			H22	PR21A	2	T	
G26	NC	-			G26	PR20B	2	C	
F26	NC	-			F26	PR20A	2	T	
E26	NC	-			E26	PR19B	2	C	
E25	NC	-			E25	PR19A	2	T	
F25	PR9B	2	C	RUM0_PLLC_FB_A	F25	PR17B	2	C	RUM0_PLLC_FB_A
GND	GND2	2			GND	GND2	2		
G25	PR9A	2	T	RUM0_PLLT_FB_A	G25	PR17A	2	T	RUM0_PLLT_FB_A
H23	PR8B	2	C	RUM0_PLLC_IN_A	H23	PR16B	2	C	RUM0_PLLC_IN_A
H24	PR8A	2	T	RUM0_PLLT_IN_A	H24	PR16A	2	T	RUM0_PLLT_IN_A
H21	PR7B	2	C		H21	PR15B	2	C	
G21	PR7A	2	T		G21	PR15A	2	T	
D26	PR6B	2	C		D26	PR14B	2	C	
D25	PR6A	2	T	RDQS6	D25	PR14A	2	T	RDQS14
F21	PR5B	2	C		F21	PR13B	2	C	
-	-	-			GND	GND2	2		
G22	PR5A	2	T		G22	PR13A	2	T	
G24	PR4B	2	C		G24	PR12B	2	C	
G23	PR4A	2	T		G23	PR12A	2	T	
C26	PR3B	2	C		C26	PR11B	2	C	
C25	PR3A	2	T		C25	PR11A	2	T	
F24	NC	-			F24	PR9B	2	C	
-	-	-			GND	GND2	2		
F23	NC	-			F23	PR9A	2	T	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
E24	NC	-			E24	PR8B	2	C	
D24	NC	-			D24	PR8A	2	T	
E22	NC	-			E22	PR7B	2	C	
F22	NC	-			F22	PR7A	2	T	
E21	NC	-			E21	PR6B	2	C	
D22	NC	-			D22	PR6A	2	T	RDQS6
E23	PR2B	2	C	VREF1_2	E23	PR2B	2	C	VREF1_2
D23	PR2A	2	T	VREF2_2	D23	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
G20	NC	-			G20	PT65B	1	C	
F20	NC	-			F20	PT65A	1	T	
D21	NC	-			D21	PT64B	1	C	
C21	NC	-			C21	PT64A	1	T	
C23	NC	-			C23	PT63B	1	C	
C22	NC	-			C22	PT63A	1	T	
B23	NC	-			B23	PT62B	1	C	
C24	NC	-			C24	PT62A	1	T	TDQS62
D20	NC	-			D20	PT61B	1	C	
-	-	-			GND	GND1	1		
E19	NC	-			E19	PT61A	1	T	
B25	NC	-			B25	PT60B	1	C	
B24	NC	-			B24	PT60A	1	T	
B26	NC	-			B26	PT59B	1	C	
A25	NC	-			A25	PT59A	1	T	
C20	NC	-			C20	PT58B	1	C	
C19	NC	-			C19	PT58A	1	T	
A24	PT57B	1	C		A24	PT57B	1	C	
-	-	-			GND	GND1	1		
A23	PT57A	1	T		A23	PT57A	1	T	
E18	PT56B	1	C		E18	PT56B	1	C	
D19	PT56A	1	T		D19	PT56A	1	T	
F19	PT55B	1	C		F19	PT55B	1	C	
B22	PT55A	1	T		B22	PT55A	1	T	
G19	PT54B	1	C		G19	PT54B	1	C	
B21	PT54A	1	T	TDQS54	B21	PT54A	1	T	TDQS54
D18	PT53B	1	C		D18	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
C18	PT53A	1	T		C18	PT53A	1	T	
F18	PT52B	1	C		F18	PT52B	1	C	
A22	PT52A	1	T		A22	PT52A	1	T	
G18	PT51B	1	C		G18	PT51B	1	C	

LatticeEC Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	10.2K
LFEC10E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	10.2K
LFEC10E-3QN208C	147	-3	Lead-Free PQFP	208	COM	10.2K
LFEC10E-4QN208C	147	-4	Lead-Free PQFP	208	COM	10.2K
LFEC10E-5QN208C	147	-5	Lead-Free PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC15E-3FN484C	352	-3	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-4FN484C	352	-4	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-5FN484C	352	-5	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	15.3K
LFEC15E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	15.3K
LFEC15E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC20E-3FN672C	400	-3	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-4FN672C	400	-4	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-5FN672C	400	-5	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	19.7K
LFEC20E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	19.7K
LFEC20E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC33E-3FN672C	496	-3	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-4FN672C	496	-4	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-5FN672C	496	-5	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	32.8K

Date	Version	Section	Change Summary
September 2005	02.0	Architecture	sysIO section has been updated.
		DC & Switching Characteristics	Recommended Operating Conditions has been updated with V_{CCPLL} .
			DC Electrical Characteristics table has been updated
			Removed 5V Tolerant Input Buffer section.
			Register-to-Register performance table has been updated (rev. G 0.28).
			LatticeECP/EC External Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Internal Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Family Timing Adders have been updated (rev. G 0.28).
			sysCLOCK PLL timing table has been updated (rev. G 0.28)
			LatticeECP/EC sysCONFIG Port Timing specification table has been updated (rev. G 0.28).
			Master Clock table has been updated (rev. G 0.28).
			JTAG Port Timing specification table has been updated (rev. G 0.28).
		Pinout Information	Signal Description table has been updated with V_{CCPLL} .
November 2005	02.1	DC & Switching Characteristics	Pin-to-Pin Performance table has been updated (G 0.30) - 4:1MUX, 8:1MUX, 16:1MUX, 32:1MUX
			Register-to-Register Performance (G 0.30) - No timing number changes.
			External Switching Characteristics (G 0.30) - No timing number changes.
			Internal Switching Characteristics (G 0.30) t_{SUP_DSP} , t_{HP_DSP} , t_{SUO_DSP} , t_{HO_DSP} , t_{COI_DSP} , t_{COD_DSP} numbers have been updated.
			Family Timing Adders (G 0.30) - No timing number changes.
			sysCLOCK PLL Timing (G 0.30) - No timing number changes.
			sysCONFIG Port Timing Specifications (G 0.30) - No timing number changes.
			Master Clock (G 0.30) - No timing number changes.
			JTAG Port Timing Specification (G 0.30) - No timing number changes.
		Ordering Information	Added 208-PQFP lead-free part numbers.
March 2006	02.2	DC & Switching Characteristics	Added footnote 3. to V_{CCAUX} in the Recommended Operating Conditions table.
January 2007	02.3	Architecture	EBR Asynchronous Reset section added.
February 2007	02.4	Architecture	Updated EBR Asynchronous Reset section.
			Updated Maximum Number of Elements in a Block table - MAC value for x9 changed to 2.
May 2007	02.5	Architecture	Updated text in Ripple Mode section.
November 2007	02.6	DC & Switching Characteristics	Added JTAG Port Waveforms diagram.
			Updated t_{RST} timing information in the sysCLOCK PLL Timing table.
		Pinout Information	Added Thermal Management text section.
		Supplemental Information	Updated title list.
February 2008	02.7	DC & Switching Characteristics	Read/Write Mode (Normal) and Read/Write Mode with Input and Output Registers waveforms in the EBR Memory Timing Diagrams section have been updated.
September 2012	02.8	All	Updated document with new corporate logo.